

N-Ch MOSFET

General Description

The WST2088 is the highest performance trench N-ch MOSFETs with extreme high cell density , which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The WST2088 meet the RoHS and Green Product requirement with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

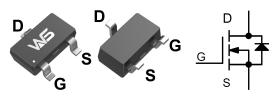
Product Summery

BVDSS	RDSON	ID
20V	8mΩ	8.8A

Applications

- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply

SOT-23-3L Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units	
V _{DS}	Drain-Source Voltage	20	V	
V _{GS}	Gate-Source Voltage	±12	V	
I _D @T _c =25℃	Continuous Drain Current, V _{GS} @ 4.5V	8.8	A	
I _D @T₀=70°C	Continuous Drain Current, V _{GS} @ 4.5V	6.2	А	
I _{DP}	Pulsed Drain Current	40	A	
P₀@T _A =25℃	Total Power Dissipation	1.5	W	
T _{STG}	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	

Thermal Data

Symbol	Parameter	Тур. Мах.		Unit	
Rthj-a	Maximum Thermal Resistance, Junction-ambient		25	°C/W	
Rthj-c	Maximum Thermal Resistance, Junction-case		8	℃/W	



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Electrical Characteristics (T_J=25 \odot , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	20			V
∆BV _{DSS} /∆T _J	BVDSS Temperature Coefficient	Reference to 25° C , I _D =1mA		0.018		V/℃
B	Statia Drain Source On Desistance ²	V _{GS} =4.5V , I _D =6A		8	13	
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =2.5V , I _D =5A		10	19	mΩ
V _{GS(th)}	Gate Threshold Voltage	V_{GS} = V_{DS} , I_D =250 uA	0.5		1.3	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =16V , V _{GS} =0V.			10	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = \pm 12V , V_{DS} =0V			±100	nA
Qg	Total Gate Charge			16		
Q _{gs}	Gate-Source Charge	V_{DS} =15V , V_{GS} =4.5V , I_{D} =6A		3		nC
Q _{gd}	Gate-Drain Charge			4.5		
T _{d(on)}	Turn-On Delay Time			10		
Tr	Rise Time	V_{DS} =10V , V_{GS} =4.5V ,		13		ns
T _{d(off)}	Turn-Off Delay Time	R _G =3.3Ω I _D =1A		28		115
T _f	Fall Time			7		
C _{iss}	Input Capacitance			1400		
C _{oss}	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		170		pF
C _{rss}	Reverse Transfer Capacitance			135		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =1A			1.2	V
t _{rr}	Reverse Recovery Time	IF=1A , V _{GS} =0V,		8.5		nS
Qrr	Reverse Recovery Charge	dl/dt=100A/µs		2.5		nC

Notes:

1.Pulse width limited by Max. junction temperature.

2.Pulse test

3.Surface mounted on 1 in² copper pad of FR4 board, t \leq 10sec ; 60 °C/W at steady state. 4.Starting T_j=25°C , V_{DD}=20V , L=0.1mH , R_G=25 Ω , V_{GS}=10V



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Typical Characteristics

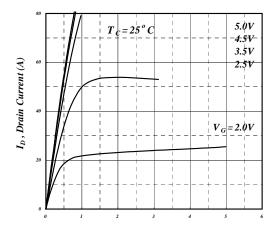


Fig 1. Typical Output Characteristics

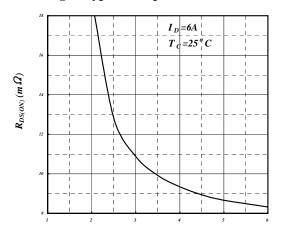
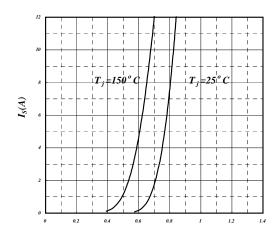
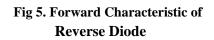


Fig 3. On-Resistance v.s. Gate Voltage





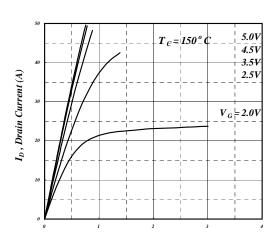


Fig 2. Typical Output Characteristics

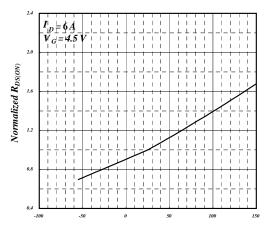
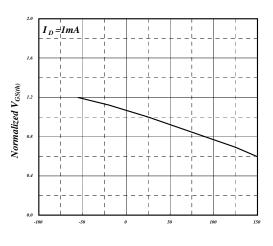
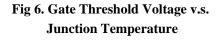


Fig 4. Normalized On-Resistance v.s. Junction Temperature







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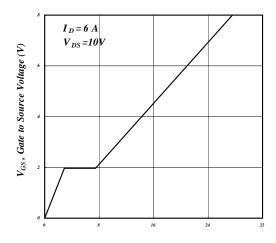


Fig 7. Gate Charge Characteristics

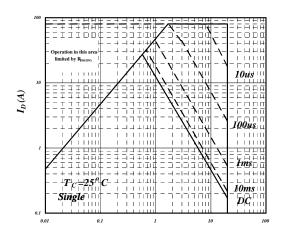


Fig 9. Maximum Safe Operating Area

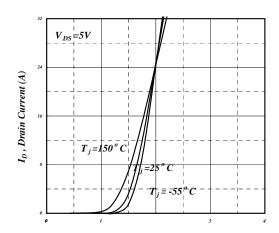


Fig 11. Transfer Characteristics

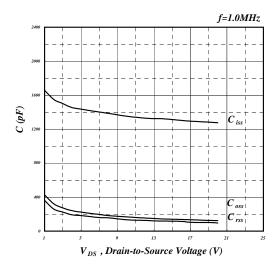


Fig 8. Typical Capacitance Characteristics

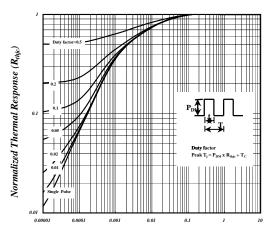


Fig 10. Effective Transient Thermal Impedance

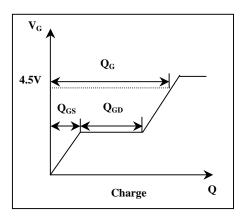
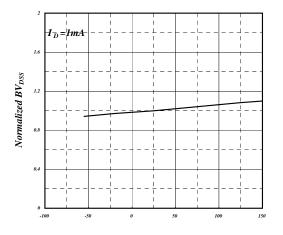
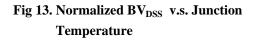


Fig 12. Gate Charge Waveform



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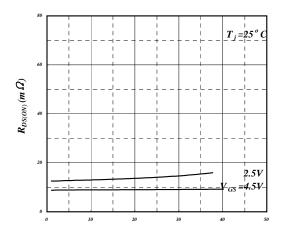


Fig 15. Typ. Drain-Source on State Resistance

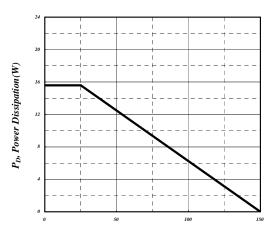


Fig 14. Total Power Dissipation



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